2-103414-0 - ACTIVE

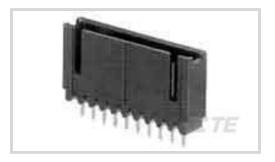
AMPMODU | AMPMODU Headers

TE Internal #: 2-103414-0 AMPMODU Headers, PCB Mount Header, Vertical, Board-to-Board, 22 Position, 2.54mm [.1in] Centerline, Shrouded, Gold, Printed Circuit Board

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 22

Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Shrouded

Connector & Contact	Terminates To
---------------------	---------------

Printed Circuit Board

Configuration Features

Number of Rows	1	
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	22	
Board-to-Board Configuration	Parallel	
Electrical Characteristics		
Insulation Resistance	5000 MΩ	
Dielectric Withstanding Voltage (Max)	750 Vrms	
Body Features		
Connector Profile	Standard	
Contact Features		
Mating Square Post Dimension	.64 mm[.025 in]	
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]	

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Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.3 mm[.13 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Color	Black
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	

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Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
CSA Certified	Yes	
CSA File Number	LR7189	
UL File Number	E28476	
Packaging Features		
Packaging Quantity	9	
Packaging Method	Tube	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUN 2020 (209) Candidate List Declared Against: JUN 2016 (169) Does not contain REACH SVHC

Solder Process Capability

Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

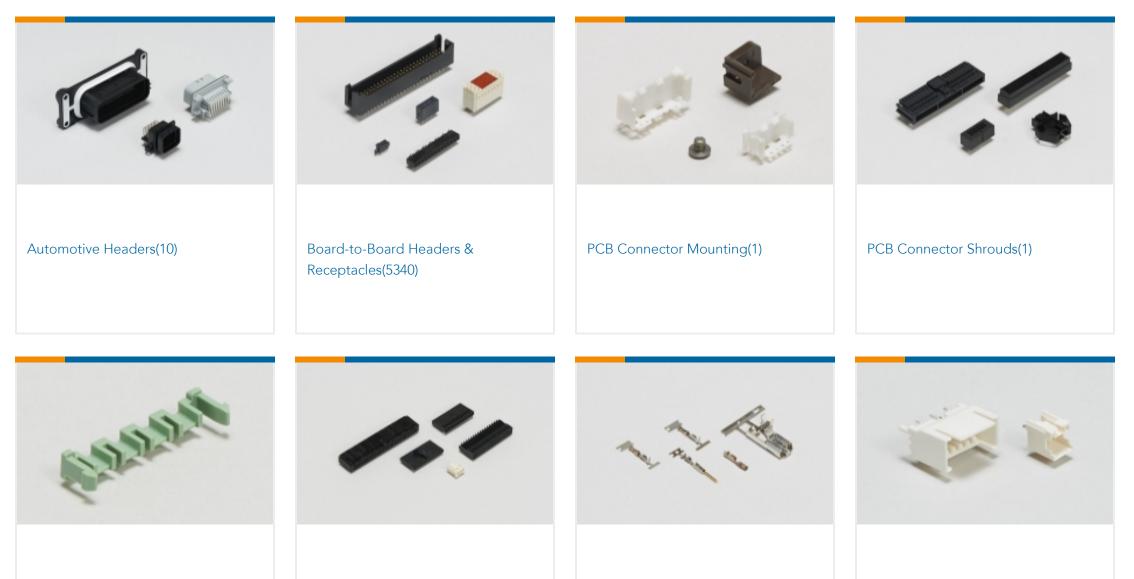
Compatible Parts

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Also in the Series AMPMODU Headers



PCB Latches, Locks & Retainers(2)	Wire-to-Board Connector Assemblies	Wire-to-Board Connector Contacts(46)	Wire-to-Board Headers & Receptacles
	& Housings(3)		(79)

Customers Also Bought



AMPMODU Headers, PCB Mount Header, Vertical, Board-to-Board, 22 Position, 2.54 mm [.1in] Centerline, Shrouded, Gold, Printed Circuit Board



Documents

Product Drawings 22 MODII HDR SRST SHRD .100CL

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_2-103414-0_P.3d_igs.zip

English

Customer View Model

ENG_CVM_2-103414-0_P.3d_stp.zip

English

Customer View Model

ENG_CVM_2-103414-0_P.2d_dxf.zip

English

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